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- Meets IBM 360/370 I/O Interface Specification GA22-6974-3 (Also See SN75ALS126)
- Minimum Output Voltage of 3.11 V at I_{OH} = - 60 mA
- Fault-Flag Circuit Output Signals Driver Output Fault
- Fault-Detection Current-Limit Circuit Minimizes Power Dissipation During a Fault Condition
- Advanced Low-Power Schottky Circuitry
- Common Enable and Common Fault Flag
- Designed to Be an Improved Replacement for the MC3485

description

The SN75ALS130 quadruple line driver is designed to meet the IBM 360/370 I/O specification GA22-6974-3. The output voltage is 3.11 V minimum (at $I_{OH} = -59.3$ mA) over the recommended ranges of supply voltage (4.5 V to 5.95 V) and temperature. Driver outputs use a fault-detection current-limit circuit to allow high drive current but still minimize power dissipation when the output is shorted to ground. The SN75ALS130 is compatible with standard TTL logic and supply voltages.

D OR N PACKAGE (TOP VIEW)							
		$\overline{\mathbf{U}}$	L				
1Y	1	16	Vcc				
1W	2	15] 4Y				
1A	[] 3	14] 4W				
G	4	13] <u>4</u> A				
2A	5	12] F				
2W	6	11] 3A				
2Y	7	10] 3W				
GND	8	9] 3Y				

NOT RECOMMENDED FOR NEW DESIGN

FUNCTION TABLE

INPU	JTS	OUTPUTS					
Gţ	Α	Y	F†	W			
L	Х	L	Н	Н			
Х	L	L	Н	н			
Н	Н	н	Н	L			
Н	Н	S	L	Н			

H = high level, L = low level,

X = irrelevant, S = shorted to ground \dagger G and \overline{F} are common to the four drivers. If any of the four Y outputs is shorted, the fault flag will respond.

The SN75ALS130 employs the IMPACT[™] process to achieve fast switching speeds and low power dissipation. Fault-flag circuitry is designed to sense and signal a line short on any Y line. Upon detecting an output fault condition, the fault-flag circuit forces the driver output into a low state and signals a fault condition by causing the fault-flag output to go low.

The SN75ALS130 can drive a 50- Ω load as required in the IBM GA22-6974-3 specification or a 90- Ω load as used in many I/O systems. Optimum performance can be achieved when the devices are used with either the SN75125, SN75127, SN75128, or SN75129 line receivers.

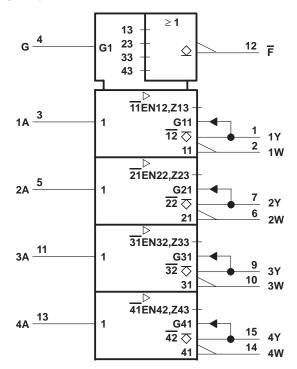
The SN75ALS130 is characterized for operation from 0°C to 70°C.

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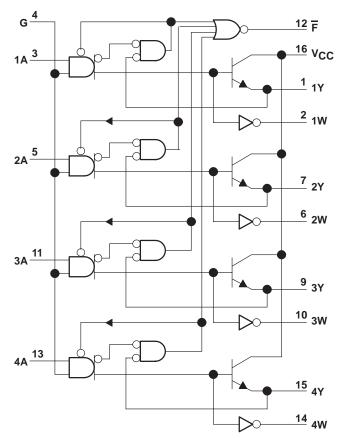
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logic symbol[†]



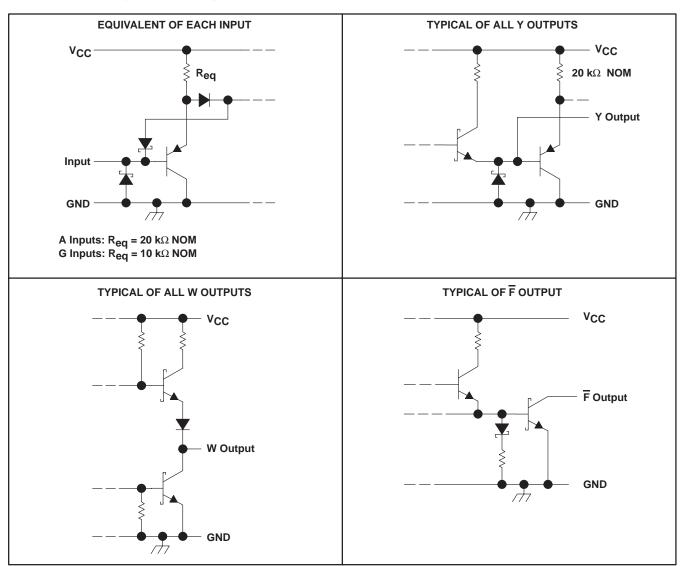
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)





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schematics of inputs and outputs

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} Input voltage	
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature range	0°C to 70°C
Storage temperature range	– 65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

DISSIPATION RATING TABLE						
PACKAGE	$T_A \le 25^{\circ}C$ POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING			
D	950 mW	7.6 mW/°C	608 mW			
N	1150 mW	9.2 mW/°C	736 mW			



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recommended operating conditions

	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.5	5	5.95	V
High-level input voltage, VIH	2			V
Low-level input voltage, VIL			0.8	V
High-level output current, I _{OH}			- 59.3	mA
Operating free-air temperature, T _A	0		70	°C

electrical characteristics over recommended operating free-air temperature range

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT	
VIK	Input clamp voltage	A,G	$V_{CC} = 4.5 V$, $I_{I} = -18 mA$		-1.5	V
		Y	V _{CC} = 4.5 V, I _{OH} = - 59.3 mA, V _{IH} = 2	V 3.11		
Vон	High-level output voltage	Y	$V_{CC} = 5.25 \text{ V}, I_{OH} = -41 \text{ mA}, V_{IH} = 2$	V 3.9		V
		W	$V_{CC} = 4.5 \text{ V}, I_{OH} = -400 \mu\text{A}, V_{IH} = 2$	V 2.5		
		Y	$V_{CC} = 5.5 \text{ V}, I_{OL} = -240 \mu\text{A}, \text{V}_{IL} = 0$	8 V	0.15	
\/		Y	$V_{CC} = 5.95 \text{ V}, I_{OL} = -1 \text{ mA}, \qquad V_{IL} = 0$	8 V	0.15	v
VOL	Low-level output voltage	F	V _{CC} = 4.5 V, I _{OL} = 8 mA, Y at 0 V	'	0.5	v
		W	V _{CC} = 4.5 V, I _{OL} = 8 mA		0.5	
1	Off state subsut sumsat	Y	$V_{CC} = 4.5 V$, $V_{IL} = 0$, $V_O = 3$.	11 V	100	
IO(off)	Off-state output current	Y	$V_{CC} = 0,$ $V_{IL} = 0,$ $V_O = 3.$	11 V	200	μA
IОН	High-level output current	F	V _{CC} = 5.95 V, V _{OH} = 5.95 V		100	μA
L.	land the summer of	А			100	μA
łį	Input current	G	$V_{CC} = 4.5 \text{ V}, \text{V}_{IH} = 5.5 \text{ V}$		400	
	Directory and a summer to	А			20	
ΙΗ	High-level input current	G	$V_{CC} = 4.5 \text{ V}, \text{V}_{IH} = 2.7 \text{ V}$		80	μA
	Low lovel input summert	А			250	
ΙL	Low-level input current	G	$V_{CC} = 5.95 \text{ V}, \text{V}_{IL} = 0.4 \text{ V}$		-1000	μA
		Y	$V_{CC} = 5.5 \text{ V}, V_{O} = 0, \qquad V_{IH} = 2$.7 V	- 5	
1	Ob ant ainsuit autrust aurrant	W	$V_{CC} = 5.5 V, V_{O} = 0$	-15	-100	
los	Short-circuit output current	Y	$V_{CC} = 5.95 V$, $V_{O} = 0$, $V_{IH} = 2$.7 V	- 5	mA
		W	$V_{CC} = 5.95 \text{ V}, V_{O} = 0$	-15	-110	
ICCH Supply current, all outputs high		-	$V_{CC} = 5.5 V$, No load, $V_{IH} = 2$.7 V	30	
			$V_{CC} = 5.95 \text{ V}$, No load, $V_{IH} = 2$.7 V	32	mA
	Cumply summer V sutmits law		$V_{CC} = 5.5 \text{ V}, \text{ No load}, \text{ V}_{IL} = 0$	4 V	45	
ICCL Supply current, Y outputs low		$V_{CC} = 5.95 \text{ V}, \text{ I}$		4 V	47	mA



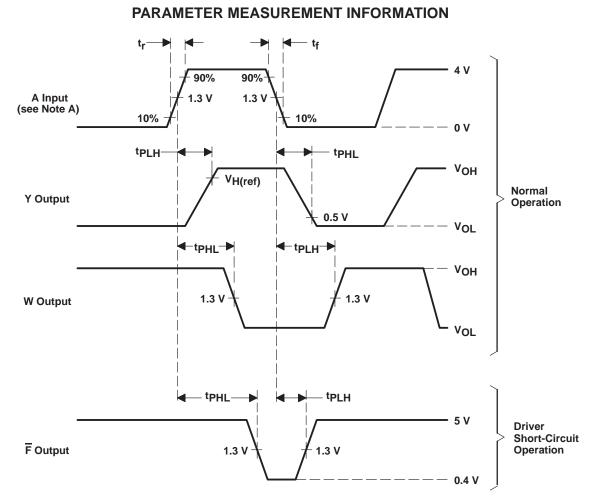
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switching characteristics over recommended operating free-air temperature range

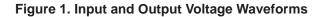
	PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	DITIONS	MIN	МАХ	UNIT
^t PLH	Propagation delay time, low- to-high-level output						30	ns
^t PHL	Propagation delay time, high- to-low-level output	А	Y $C_C = 4.5 V t_C$ Y $C_L = 50 pF$, Input f = 1 MH	$V_{CC} = 4.5 V \text{ to } 5.5 V,$ $C_{L} = 50 \text{ pF},$ Input f = 1 MHz,	$R_L = 50 \Omega$, V _{H(ref)} = 3.11 V, See Figures 1 and 2		28	ns
tplh tphl	Ratio of propagation delay times			input i = i minz,		0.3	3	
^t PLH	Propagation delay time, low- to-high-level output	A Y	$V_{CC} = 5.25 V \text{ to } 5.95 V,$			34	ns	
^t PHL	Propagation delay time, high- to-low-level output		Ť	$C_L = 50 \text{ pF},$ Input f = 5 MHz,	VH(ref) = 3.9 v, See Figures 1 and 2		34	ns
^t PLH	Propagation delay time, low- to-high-level output	A	w	V _{CC} = 5 V, C _L = 15 pF,	$R_L = 2 k\Omega$, See Figures 1 and 2		34	ns
^t PHL	Propagation delay time, high- to-low-level output						21	ns
^t PLH	Propagation delay time, low- to-high-level output	A	F	V _{CC} = 5 V, C _L = 15 pF,	RL = 2 kΩ,		45	ns
^t PHL	Propagation delay time, high- to-low-level output		r"		See Figures 1 and 2		75	ns



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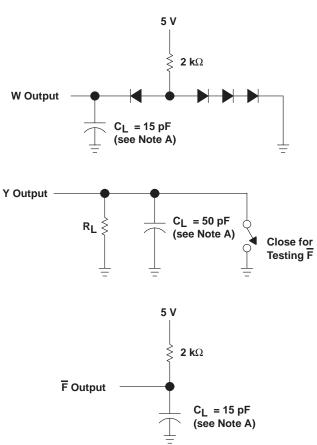


NOTE A: The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, duty cycle \leq 50%, t_{f} \leq 6 ns, t_{f} \leq 6 ns, Z_{O} \approx 50 Ω .





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PARAMETER MEASUREMENT INFORMATION









PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN75ALS130N	OBSOLETE	PDIP	Ν	16	TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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